

1 In the Specification

2 At p. 1 before the "Technical Field" section, please insert the
3 following:

4 --RELATED PATENT DATA

5 This patent resulted from a divisional application of U.S. Patent
6 Application Serial No. 09/022,812, filed February 12, 1998, entitled "Thin
7 Profile Battery Bonding Method and Method of Conductively
8 Interconnecting Electronic Components" (As Amended), naming Rickie C.
9 Lake as inventor, and which is now U.S. Patent No. 6,030,423, the
10 disclosure of which is incorporated by reference.--

11
12 Delete the language starting on Page 9, line 20, starting with the
13 word "Example" through Page 10, line 12 through "disclosures.", as
14 directed to non-essential matter.

15
16 In the Claims

17 Cancel claims 1-8 and 15-22 without prejudice.
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